

# A Novel High-Resolution Mapping of d-Spacing and Lattice Plane Orientation in boron high-doped silicon single crystal wafers

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## Introduction

A novel, fast and stable crystal lattice-spacing comparator have been developed at BL3C2 of the Photon Factory, which can complete one measurement process within a few tens of seconds with resolution of  $10^{-8}$ .<sup>1)</sup> Because local variations in a crystal are not only in d-spacing, but also in orientation of the lattice plane<sup>2)</sup>, it is necessary to add a function in the comparator system to measure local orientations of a crystal.

Since using a pair of quasi-simultaneous Bragg diffractions of two equivalent indexes in a sample is the principle of our lattice-spacing comparator, only utilizing a combination of the comparator with an autocollimator as shown in FIGURE 1, both d-spacing and lattice plane orientation ( $\Delta\alpha$ ) in the same location of the crystal can be measured without any additional sample movements. In case of 117 and -1-17 as a pair of quasi-simultaneous Bragg diffractions indexes, a particular wavelength for these two diffractions was chosen as 0.149088nm by a monolithic double-crystal monochromator (MDCM) that is framed by two channel-cuts of 117 and -1-17 with (+, -, -, +) arrangement on a monolithic silicon crystal.

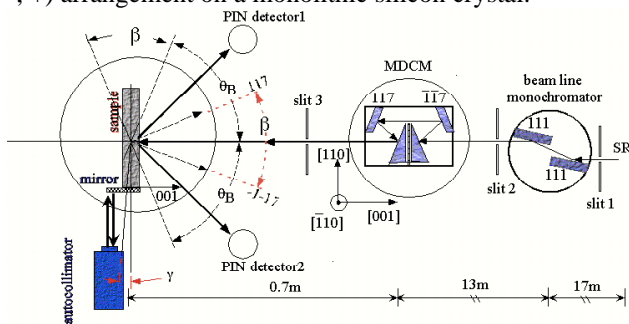


FIGURE 1. Schematic side view of the experimental arrangement.

## Experiment and data analysis

The sample is a quarter 8" boron high-doped CZ silicon wafer where -1-10 surface is bottom and 001 surface is almost perpendicular to the incident x-ray beam. The incident beam size is 1(V) x 2(H) mm<sup>2</sup>. Details of tuning of the comparator and measuring process has been described in reference 1 and 3. Because one measurement process can be finished within a few ten seconds, local lattice variations of 1,600 positions were measured in about 20 hours. The relative changes of d-spacing  $\Delta d/d$  can be obtained from next formula, where  $\theta_B$  is 78.5782°.

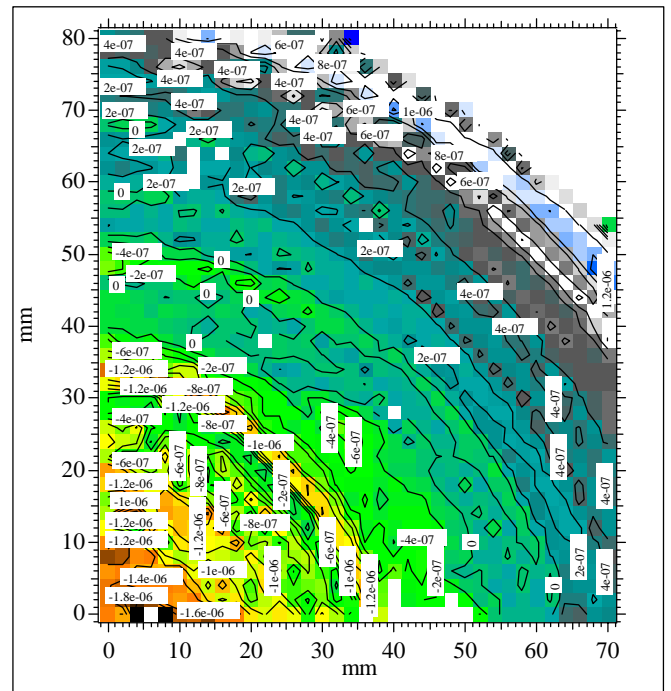
$$\Delta d/d = 1/\tan\theta_B \times \Delta\theta = 1/\tan\theta_B \times (P_1 - P_2)/2 = 1/\tan\theta_B \times \gamma/2$$


FIGURE 2. 2D imaging plots with contour of deviation from  $\Delta d/d$  on the sample, B conc.:  $2.8 \times 10^{19} \text{ cm}^{-3}$ .  $\Delta d/d$  is  $-1.594 \times 10^{-4}$ .

The variations in orientation of the lattice can be obtained from next formula, where  $\alpha_0$  is an initial attitude of the sample monitored by the autocollimator.

$$\Delta\alpha = (P_1 + P_2) / 2 - \alpha_0$$

Finally, the serial data of d-spacing were converted to 2D matrix, and plotted in FIGURE 2 with units of  $\Delta d/d$ , and where d is standard value of silicon, 0.543107 nm (at 25.0 C). We are able to recognize a variation of  $2 \times 10^{-7}$  ( $\Delta d/d$ ), and it seems that this is due to variation of boron concentration ( $2 \times 10^{16} \text{ cm}^{-3}$ ). It was found that a center of wafer is higher concentration of  $5 \times 10^{17} \text{ cm}^{-3}$  of boron than average.

Furthermore, orientation of the lattice plane of 10 arc-sec across a wafer was discovered by above method of BL3C2 and a plain topograph of BL15C.

## References

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